

Features

- 0201 0.35mm SMD LED
- High Brightness
- InGaN Technology
- Small package
- High reliability
- Clear Lens

Applications

- Consumer Electronics
- Wearables
- Automobile After Market
- Industrial Equipment

Description

The IN-S21AT2B is a popular low profile 0201 package with versatile design capabilities. It is a PCB type molding style LED which can be used in various applications.

Recommended Solder Pattern

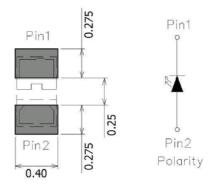
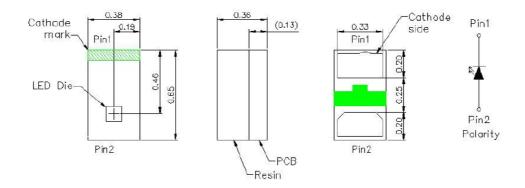


Figure 1. IN-S21AT2B Solder Pattern

Package Dimensions in mm



Notes.

- 1. All dimensions are in millimeters.
- 2. Tolerance is ± 0.05 mm unless otherwise noted

Figure 2. IN-S21AT2B Package Dimensions



Absolute Maximum Rating at 25°C (Note 1)

Product	Emission Color	P _d (mW)	I _F (mA)	I _{FP} * (mA)	V _R (V)	T _{OP} (°C)	T _{ST} (°C)
IN-S21AT2B	Blue	6.2	2	15	5	-40°C~+80°C	-40°C~+100°C

Notes

1. Condition for IFP is pulse of 1/10 duty and 0.1msec width

ESD Precaution

ATTENTION: Electrostatic Discharge (ESD) protection



The symbol above denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AllnGaP, GaN, or/and InGaN based chips are STATIC SENSITIVE devices. ESD precaution must be taken during design and assembly.

If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

Please be advised that normal static precautions should be taken in the handling and assembly of this device to prevent damage or degradation which may be induced by electrostatic discharge (ESD).



Electrical Characteristics T_A = 25°C (Note 1)

	Emission		∨ _F (∨)		λ (nm)			Viewing Angle	I* _V (mcd)
Product	Emission Color	$I_F(mA)$	Тур	max	λD	λP	Δλ	2 0 1/2	typ.
IN-S21AT2B	Blue	2	2.6	3.3	468	463	16	110	15

Notes

Luminous Intensity (Iv) Bin:

Bin	Luminous Intensity Range (mcd)						
	Minimum	Maximum					
K	7.15	11.25					
L	11.25	18.0					
М	18.0	28.5					

@2mA / Ta=25 $^{\circ}$ C, Tolerance: $\pm 10\%$

Forward Voltage (VF) Bin:

Color	Bin Code	Spec. Range
	G5	2.4-2.6V
Blue	G6	2.6-2.8V
blue	H5	2.8-3.0V
	H6	3.0-3.2V

@2mA / Ta=25 $^{\circ}$ C, Tolerance: \pm 0.05 V

Wavelength Bin: (VF) Bin:

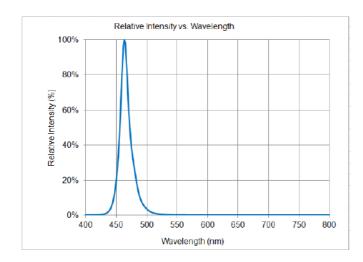
Color	Bin Code	Spec. Range
	AA	460-465nm
Blue	AB	465-470nm
	AC	470-475nm

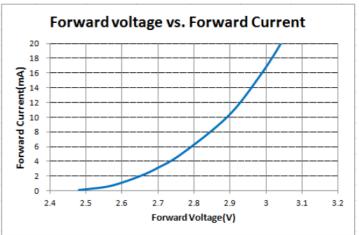
@2mA / Ta=25 $^{\circ}$ C, Tolerance: \pm 0.5nm

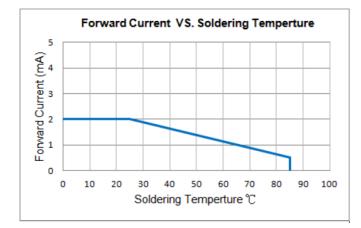
^{1.} Performance guaranteed only under conditions listed in above tables.

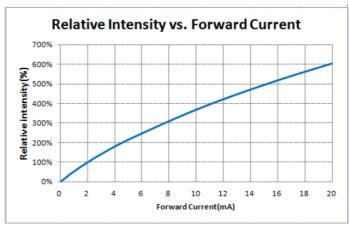


Typical Characteristic Curves



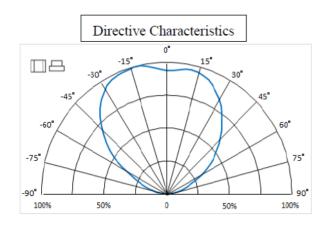


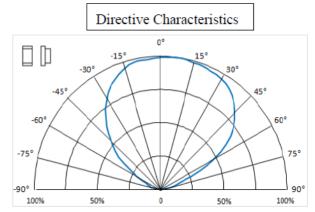






Typical Characteristic Curves – Radiation Pattern



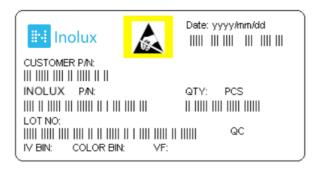


Ordering Information

Product	Emission Color	Technology	Test Current I _F (mA)	Luminous Intensity I _V (mcd) (Typ.)	Forward Voltage V _F (V) (Typ.)	Orderable Part Number
IN-S21AT2B	Blue	InGaN	2	15	3.0	IN-S21AT2B



Label Specifications



Inolux P/N:

I	N	-	S	2	1	А	Т	2		В	-	- - -
			Material	Pacl	kage	Variation	Orientation	Current	Lens	Color		Customized Stamp-off
	olux MD		S = PCB Type	21	.A = 0.6 0.36	5 x 0.38x mm	T = Top Mount	2=2mA	(Blank) = Clear U = Diffused	B = 468nm		

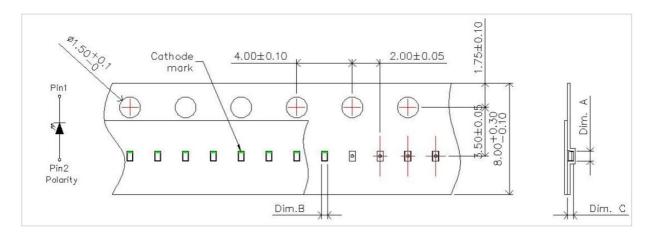
Lot No.:

Z	2	0	1	7	01	24	001
Internal		Voor (2017	Month	Data	Serial		
Tracker		fear (2017	, 2018,)		IVIOITUI	Date	Seriai



Packaging Information: 4000pcs Per Reel

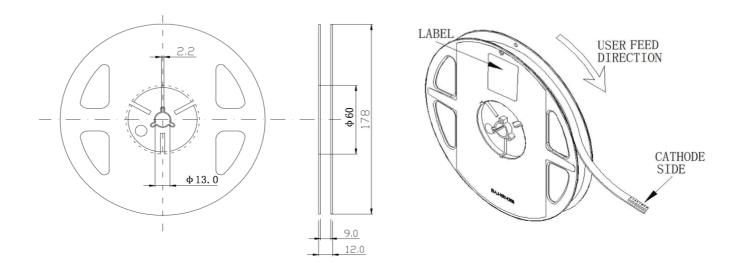
Tape Dimension



Dim. A	Dim. B	Dim. C	Q'ty/Reel
0.74±0.03	0.47±0.03	0.41±0.03	4K

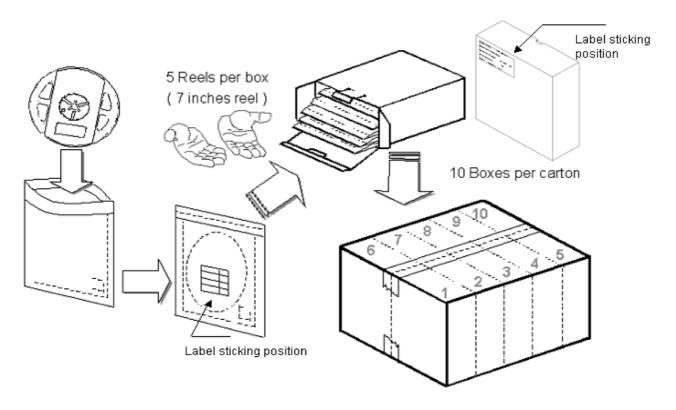
Unit: mm

Reel Dimension





Packing Dimension



5 boxes per carton are available depending on shipment quantity.

	Specification	Material	Quantity
Carrier tape	Per EIA 481-1A specs	Conductive black tape	4000pcs per reel
Reel	Per EIA 481-1A specs	Conductive black	
Label	IN standard	Paper	
Packing bag	220x240mm	Aluminum laminated bag/ no-zipper	One reel per bag
Carton	IN standard	Paper	Non-specified
Othoro			

Others:
Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of Iv, λ_D and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

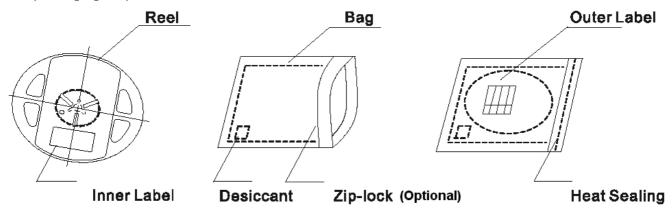


Dry Pack

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

Upon request, a humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

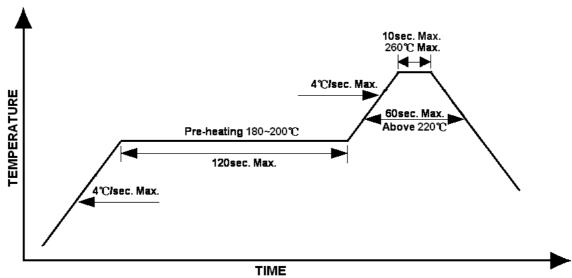
The packaging sequence is as follows:



Reflow Soldering

- Recommended tin glue specifications: melting temperature in the range of 178~192 °C
- The recommended reflow soldering profile is as follows (temperatures indicated are as measured on the surface of the LED resin):

Lead-free Solder Profile





Precautions

- Avoid exposure to moisture at all times during transportation or storage.
- Anti-Static precaution must be taken when handling GaN, InGaN, and AllnGaP products.
- It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage.
- Avoid operation beyond the limits as specified by the absolute maximum ratings.
- Avoid direct contact with the surface through which the LED emits light.
- If possible, assemble the unit in a clean room or dust-free environment.

Reworking

- Rework should be completed within 5 seconds under 260 °C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultra sonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 °C max, <3min

Cautions of Pick and Place

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electro-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.



IN-S21AT2B Top View SMD LED 0201 PCB Type

Reliability

enability			
Item	Frequency/ lots/ samples/ failures	Standards Reference	Conditions
	For all reliability	J-STD-020	1.) Baking at 85°C for 24hrs
Dragondition		J-81D-020	
Precondition	monitoring tests according		2.) Moisture storage at 85°C/ 60% R.H. for
	to JEDEC Level 2	JEODOO DAOO D	168hrs
0 1 1 1 111	1Q/ 1/ 22/ 0	JESD22-B102-B	Accelerated aging 155°C/ 24hrs
Solderability		And CNS-5068	Tinning speed: 2.5+0.5cm/s
			Tinning: A: 215°C/ 3+1s or B: 260°C/ 10+1s
		CNS-5067	Dipping soldering terminal only
Resistance to			Soldering bath temperature
soldering heat			A: 260+/-5°C; 10+/-1s
			B: 350+/-10°C; 3+/-0.5s
	1Q/ 1/ 40/ 0	CNS-11829	1.) Precondition: 85°C baking for 24hrs
Operating life test			85°C/ 60%R.H. for 168hrs
			2.) Tamb25°C; IF=20mA; duration 1000hrs
High humidity,	1Q/ 1/ 45/ 0	JESD-A101-B	Tamb: 85°C
high temperature			Humidity: 85% R.H., IF=5mA
bias			Duration: 1000hrs
	1Q/ 1/ 20	IN specs.	Tamb: 55°C
High temperature	= .		IF=20mA
bias			Duration: 1000hrs
	1Q/ 1/ 40/ 0		Tamb25°C, If=20mA,, Ip=100mA, Duty
Pulse life test	1 2, 1, 19, 9		cycle=0.125 (tp=125 μ s,T=1sec)
disc inc test			Duration 500hrs)
	1Q/ 1/ 76/ 0	JESD-A104-A	A cycle: -40 degree C 15min; +85 degree C
	10/1/70/0	IEC 68-2-14, Nb	15min
Temperature		1EC 00-2-14, ND	Thermal steady within 5 min
cycle			
			300 cycles
I Darla Januara Salita	10/1/10/0	ONIO 0447	2 chamber/ Air-to-air type
High humidity	1Q/ 1/ 40/ 0	CNS-6117	60+3°C
storage test	10/1/10/0	0110 == 4	90+5/-10% R.H. for 500hrs
High temperature storage test	1Q/ 1/ 40/ 0	CNS-554	100+10°C for 500hrs
Low temperature	1Q/ 1/ 40/ 0	CNS-6118	-40+5°C for 500hrs
storage test	1 13, 3		13.12.2.30.300
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Revision History

Changes since last revision	Page	Version No.	Revision Date
Initial Release		1.0	10-16-2019
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